Armstrong, Kratz, Quintos, Hanson & Brooks, LLP

DECLARATION FOR U.S. PATENT APPLICATION

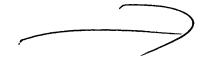
As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled: ADSORBENT_OF LATENT-HEAT STORAGE TYPE FOR CANISTER AND PROCESS FOR PRODUCING THE SAME the specification of which is attached hereto unless the following is checked was filed on <u>June 6, 2003</u> as United States Application Number or PCT International Application Number PCT/JP03/07177 and was amended on _____ (if applicable). I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claim(s), as amended by any amendment referred above. I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56. I hereby claim foreign priority benefits under Title 35, United States Code, § 119 (a) - (d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application for which priority is claimed. **Priority Claimed** (List prior foreign ☐ Yes ☐ No 18/06/2002 applications. See Japan 2002-176650 note A) (Day/Month/Year Filed) (Country) (Number) 20/08/2002 Japan 2002-238797 (Day/Month/Year Filed) (Country) (Number) ☐ Yes ☐ No (Day/Month/Year Filed) (Country) (Number) ☐ Yes ☐ No (Day/Month/Year Filed) (Country) (Number) See attached list for additional prior foreign applications (See note B) I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application. Status (List prior U.S. Patented Pending Abandoned Applications) (Filing Date) (Application Serial No.) Patented Pending Abandoned (Filing Date) (Application Serial No.) Patented Pending Abandoned

(Filing Date)

(Application Serial No.)



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I hereby apportant Patent and Tr	oint the following attorner rademark Office connecte	y(s) and/or agent(s) to prosecute this appl d therewith:	10/51694	1
		23850 PATENT TRADEMARK OFFICE		
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Please direct	all communications to the	e following address:		
		23850 PATENT TRADEMARK OFFICE		
information	and belief are believed to statements and the like as Code, ' 1001 and that thereon.	so be true; and further that these statemers on made are punishable by fine or improduced willful false statements may jeopard	the true and that all statements made on the ents were made with the knowledge that isonment, or both, under Title 18 of the dize the validity of the application or any	
(See note C)		st inventor (given name, family name)	Date November 26, 2004	
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	Full name of third invo Inventor's signature	entor (given name, family name)	Date	
	Residence		Citizenship	
	Post Office Address			
	Full name of fourth in Inventor's signature	ventor (given name, family name)	Date	
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